

XL-DZ324SURSYGW/B技术数据表F3MM 红普绿双色灯座共阳

特点（ ）：

- * :7.0*5.0*6.5mm
- Appearance dimension :7.0*5.0*6.5mm
- * : /
- Luminous color and colloid: Red Green Light /water colloid
- * ROHS
- Environmental protection products meet ROHS requirements
- * MSL :2
- Moisture sensitivity level MSL : 2 levels
- * EIA
- EIA standard packaging
- *
- Long operating life
- *
- Reduced maintenance costs
- *
- High energy efficiency, fast startup

应用领域 (product application)

- *
- Internet of Things
- *
- medical treatment
- *
- converter
- *

目录

Catalan

由性參新

Max Power Dissipation	PD	R	50	mW
		G	50	
Max Continuous Forward Current	IF	R	20	mA
		G	20	
Peak Forward Current	IFP	R	80	mA
		G	80	
Max Reverse Voltage	VR	5		V
Antistatic ability	ESD	2000		V
Operating Temperature Range	TOPR	-40 ~ +85		
Storage Temperature Range	TSTR	-40 ~ +85		
/ Lead Soldering Temperature/Time	TSOL	260 6S		/S

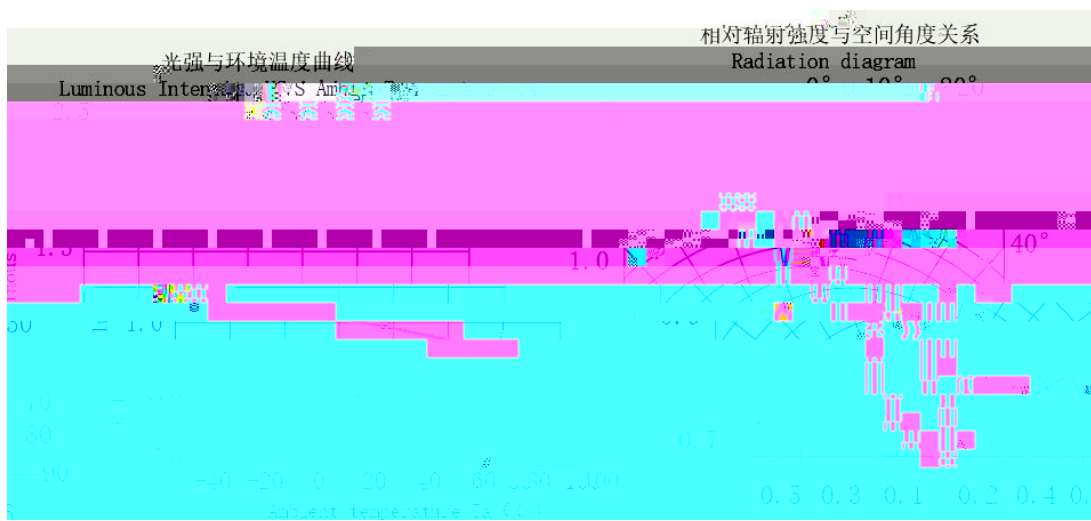
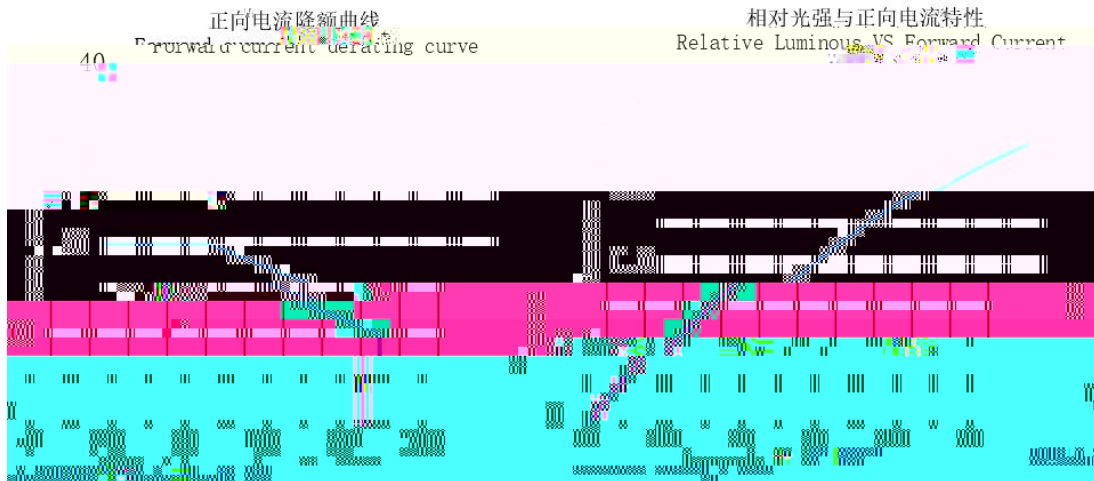
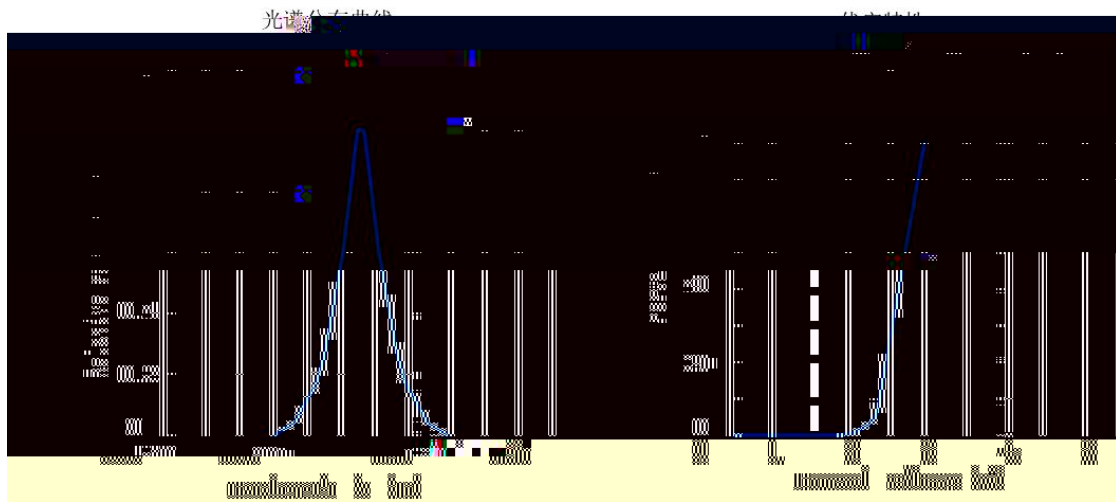


亮度分档

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电压分档

典型特性曲线



25 ± 5 °C./Note: If not otherwise indicated, the test environment temperature is 25 ± 5 °C.



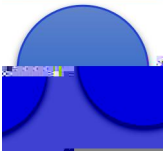
可靠性试验

Reliability Test Items And Conditions

Class	Test item	Testing environment	Testing time	Qty	Fail qty
Endurance test	Working life	Ta=25 ± 5 , IF=20mA	1000hrs	22 PCS	0/1
	High temperature and high humidity experiment	Ta= 85 ± 5 , RH= 85 ~ 90%	1000hrs	22 PCS	0/1
	High-temperature storage	Ta= 85 ± 5	1000hrs	22 PCS	0/1
	Low temperature storage	Ta= -40 ± 5	1000hrs	22 PCS	0/1
Environmental testing	Cold and hot cycle	100 ± 5 30mins 5mins -40 ± 5 30mins	100 Circles	22 PCS	0/1
	Hot and cold impact	105 ± 5 5mins -45 ± 5 5mins	100 Circles	22 PCS	0/1
Mechanical Test	Resistance to Soldering Heat	T.sol= 250 ± 5	2times	22 PCS	0/1
	Lead Integrity	Load 2.5N(0.25kgf) 0 ° ~ 90 ° ~0 °	3times	22 PCS	0/1

外形尺寸

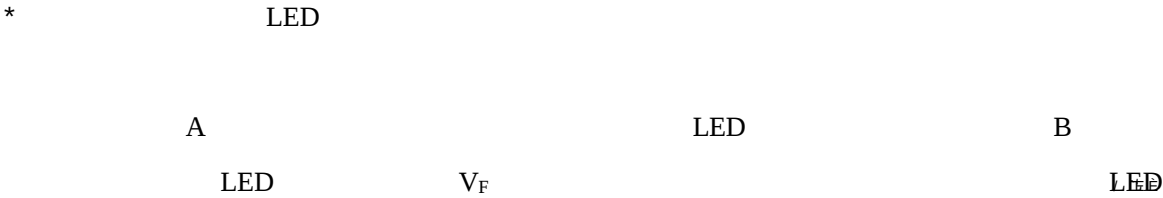
包装



使用注意事項 (2)

Precautions (2)

※ 設計建議



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